

SM-8 BIPOLAR TRANSISTOR H-BRIDGE

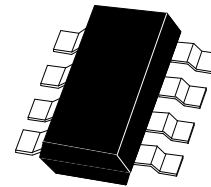
ZHB6790

PRELIMINARY DATA SHEET ISSUE B JULY 1997

FEATURES

- * Compact package
- * Low on state losses
- * Low drive requirements
- * Operates up to 40V supply
- * 2 Amp continuous rating

PARTMARKING DETAIL – ZHB6790

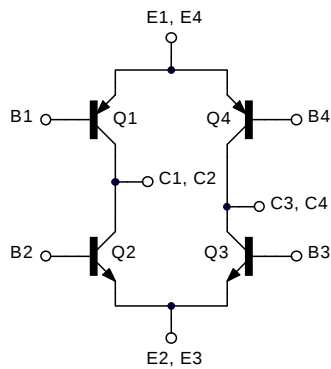


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(8 LEAD SOT223)

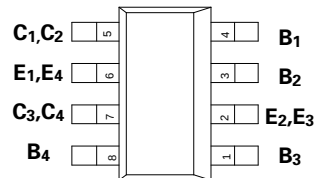
ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	NPNs	PNPs	UNIT
Collector-Base Voltage	V_{CBO}	50	-50	V
Collector-Emitter Voltage	V_{CEO}	40	-40	V
Emitter-Base Voltage	V_{EBO}	5	-5	V
Peak Pulse Current	I_{CM}	6	-6	A
Continuous Collector Current	I_C	2	-2	A
Operating and Storage Temperature Range	$T_j:T_{stg}$	-55 to +150		°C

SCHEMATIC DIAGRAM



CONNECTION DIAGRAM



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PNP TRANSISTORS ELECTRICAL CHARACTERISTICS (at $T_{amb} = 25^{\circ}\text{C}$).

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	-50			V	$I_C = -100\mu\text{A}$
Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	-40			V	$I_C = -10\text{mA}^*$
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	-5			V	$I_E = -100\mu\text{A}$
Collector Cutoff Current	I_{CBO}			-0.1	μA	$V_{CB} = -30\text{V}$
Emitter Cutoff Current	I_{EBO}			-0.1	μA	$V_{EB} = -4\text{V}$
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$			-0.14 -0.25 -0.45 -0.75	V V V V	$I_C = -100\text{mA}, I_B = -0.5\text{mA}^*$ $I_C = -500\text{mA}, I_B = -5\text{mA}^*$ $I_C = -1\text{A}, I_B = -10\text{mA}^*$ $I_C = -2\text{A}, I_B = -50\text{mA}^*$
Base-Emitter Saturation Voltage	$V_{BE(sat)}$			-1.0	V	$I_C = -1\text{A}, I_B = -10\text{mA}^*$
Base-Emitter Turn-On Voltage	$V_{BE(on)}$		-0.75		V	$I_C = -1\text{A}, V_{CE} = -2\text{V}^*$
Static Forward Current Transfer Ratio	h_{FE}	300 200 150				$I_C = -100\text{mA}, V_{CE} = -2\text{V}$ $I_C = -1\text{A}, V_{CE} = -2\text{V}^*$ $I_C = -2\text{A}, V_{CE} = -2\text{V}^*$
Transition Frequency	f_T	100			MHz	$I_C = -50\text{mA}, V_{CE} = -5\text{V}$ $f = 50\text{MHz}$
Input Capacitance	C_{ibo}		225		pF	$V_{EB} = -0.5\text{V}, f = 1\text{MHz}$
Output Capacitance	C_{obo}		24		pF	$V_{CB} = -10\text{V}, f = 1\text{MHz}$
Switching Times	t_{on} t_{off}		35 600		ns	$I_C = -500\text{mA},$ $I_{B1} = -50\text{mA}$ $I_{B2} = -50\text{mA}, V_{CC} = -10\text{V}$

*Measured under pulsed conditions. Pulse width=300 μs . Duty cycle $\leq 2\%$.

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NPN TRANSISTORS

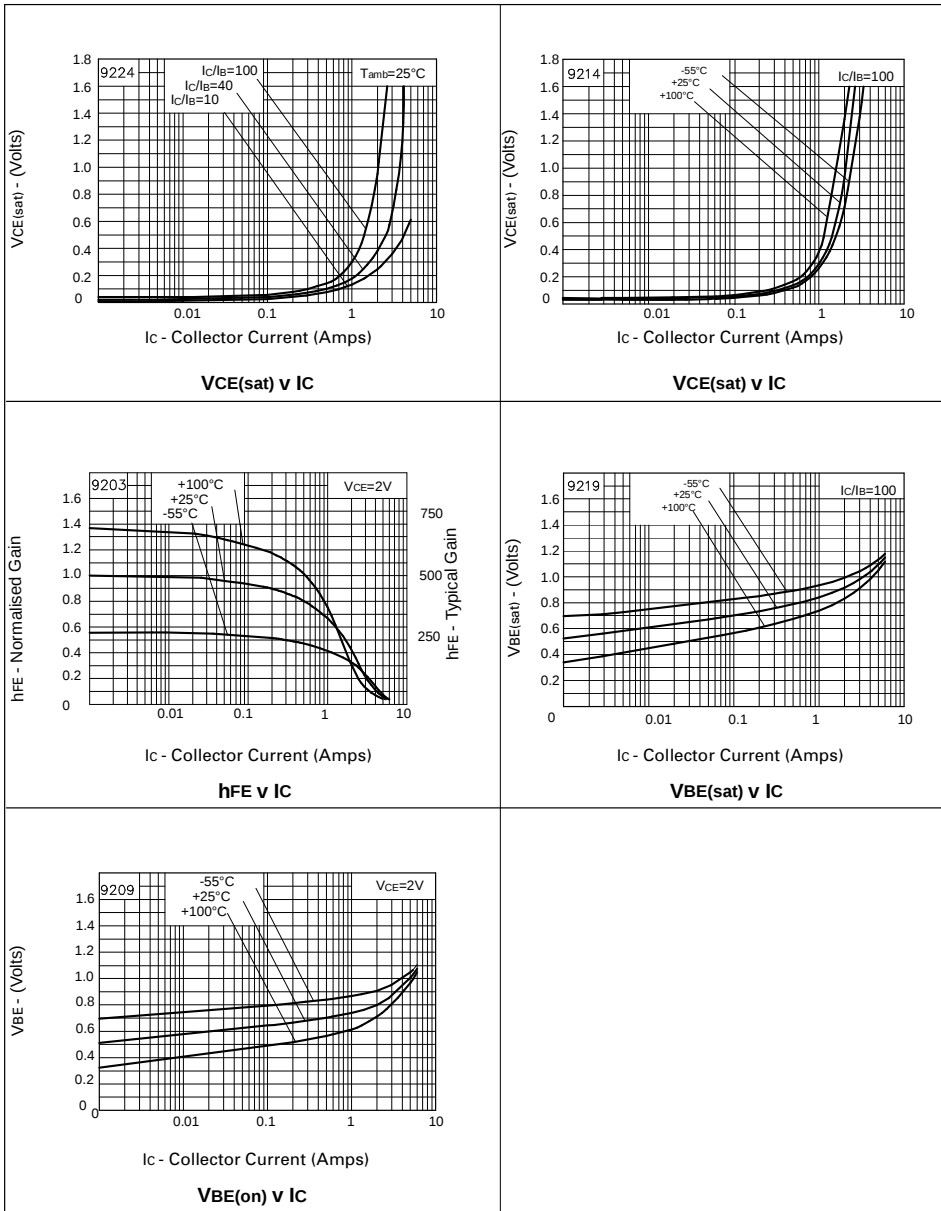
ELECTRICAL CHARACTERISTICS (at $T_{amb} = 25^{\circ}\text{C}$).

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	50			V	$I_C=100\mu\text{A}$
Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	40			V	$I_C=10\text{mA}^*$
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	5			V	$I_E=100\mu\text{A}$
Collector Cutoff Current	I_{CBO}			0.1	μA	$V_{CB}=35\text{V}$
Emitter Cutoff Current	I_{EBO}			0.1	μA	$V_{EB}=4\text{V}$
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$			0.1 0.16 0.5 0.35	V V V V	$I_C=100\text{mA}, I_B=0.5\text{mA}^*$ $I_C=500\text{mA}, I_B=2.5\text{mA}^*$ $I_C=1\text{A}, I_B=5\text{mA}^*$ $I_C=2\text{A}, I_B=30\text{mA}^*$
Base-Emitter Saturation Voltage	$V_{BE(sat)}$			0.9	V	$I_C=1\text{A}, I_B=10\text{mA}^*$
Base-Emitter Turn-On Voltage	$V_{BE(on)}$		0.73		V	$I_C=1\text{A}, V_{CE}=2\text{V}^*$
Static Forward Current Transfer Ratio	h_{FE}	500 400 150				$I_C=100\text{mA}, V_{CE}=2\text{V}^*$ $I_C=1\text{A}, V_{CE}=2\text{V}^*$ $I_C=2\text{A}, V_{CE}=2\text{V}^*$
Transition Frequency	f_T	150			MHz	$I_C=50\text{mA}, V_{CE}=5\text{V}$ $f=50\text{MHz}$
Input Capacitance	C_{ibo}		200		pF	$V_{EB}=0.5\text{V}, f=1\text{MHz}$
Output Capacitance	C_{obo}		16		pF	$V_{CB}=10\text{V}, f=1\text{MHz}$
Switching Times	t_{on} t_{off}		33 1300		ns	$I_C=500\text{mA}, I_{B1}=50\text{mA}$ $I_{B2}=50\text{mA}, V_{CC}=10\text{V}$

*Measured under pulsed conditions. Pulse width=300 μs . Duty cycle $\leq 2\%$.

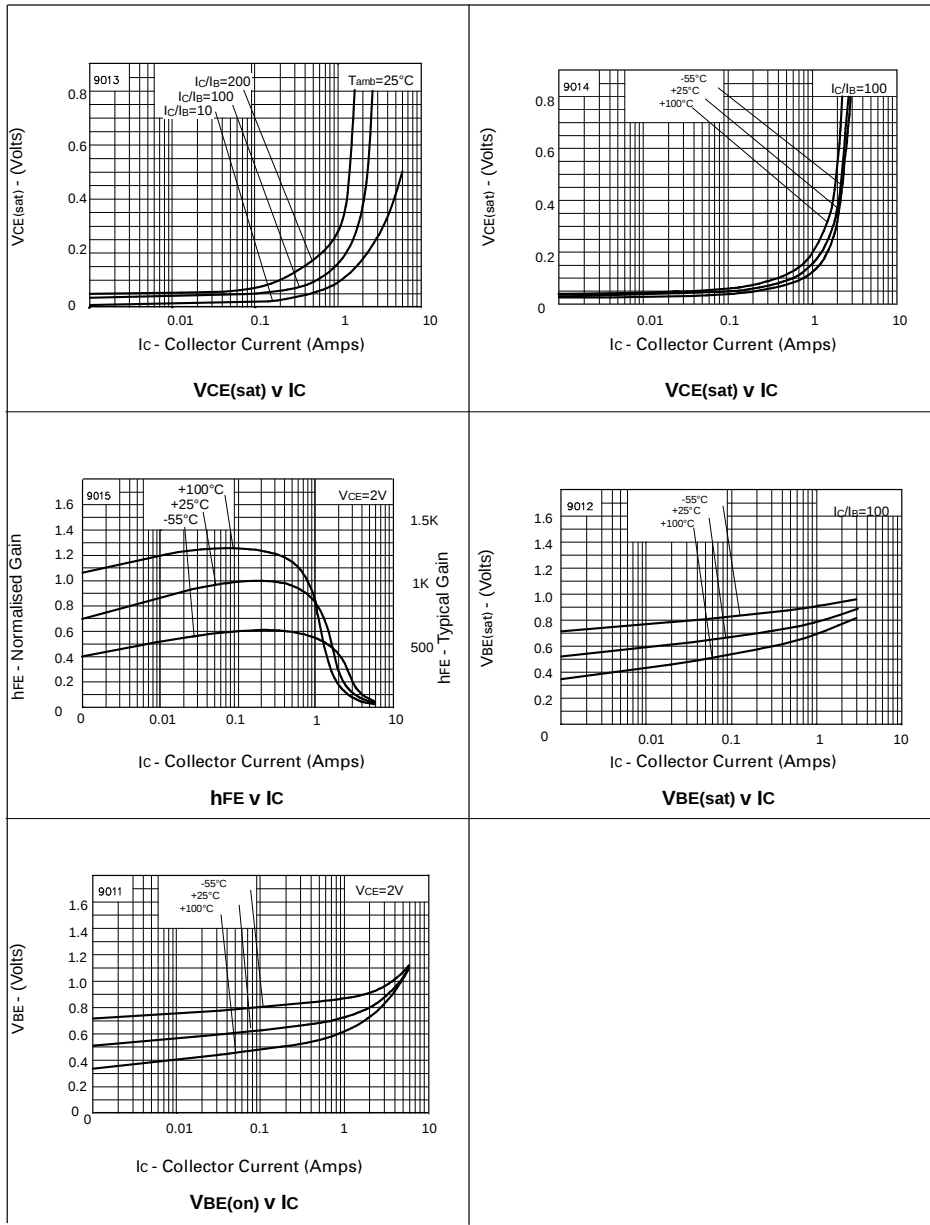
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**PNP TRANSISTOR
TYPICAL CHARACTERISTICS**



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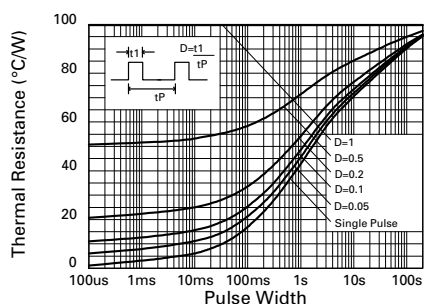
NPN TRANSISTOR TYPICAL CHARACTERISTICS



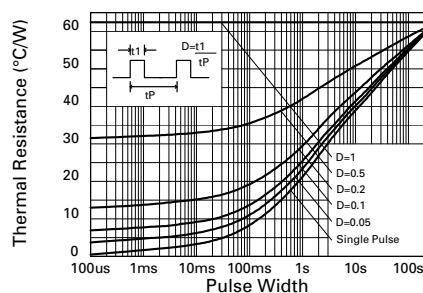
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THERMAL CHARACTERISTICS

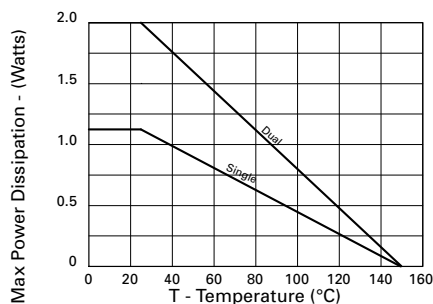
PARAMETER	SYMBOL	VALUE	UNIT
Total Power Dissipation at $T_{amb} = 25^{\circ}\text{C}^*$ Any single transistor "on" Q1 and Q3 "on" or Q2 and Q4 "on" equally	P_{tot}	1.25 2	W W
Derate above 25°C^* Any single transistor "on" Q1 and Q3 "on" or Q2 and Q4 "on" equally		10 16	mW/ $^{\circ}\text{C}$ mW/ $^{\circ}\text{C}$
Thermal Resistance - Junction to Ambient* Any single transistor "on" Q1 and Q3 "on" or Q2 and Q4 "on" equally		100 62.5	$^{\circ}\text{C}/\text{W}$ $^{\circ}\text{C}/\text{W}$



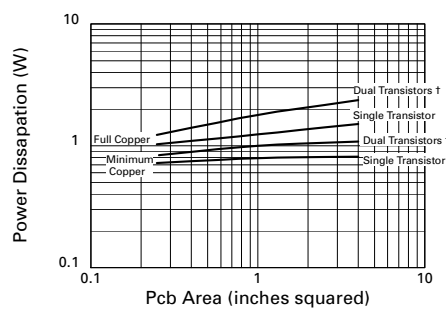
**Transient Thermal Resistance
Single Transistor "On"**



**Transient Thermal Resistance
Q1 and Q3 or Q2 and Q4 "On"**



Derating curve



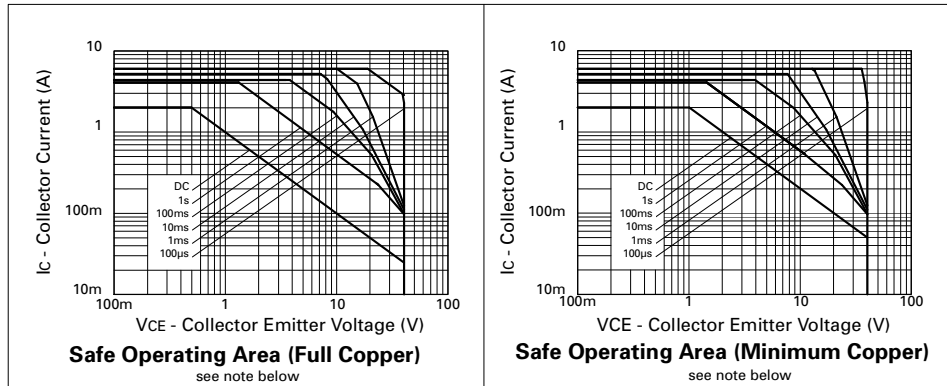
Pd v Pcb Area Comparison

* The power which can be dissipated assuming the device is mounted in a typical manner on a PCB with copper equal to 2 inches square.

t"Two devices on" is the standard operating condition for the bridge. Eg. opposing NPN/PNP pairs turned on.

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SAFE OPERATING AREA



Note: The Safe Operating Area (SOA) charts shown are a combination of the worst case secondary breakdown characteristics for the NPN/PNP pair, and the thermal curves demonstrating the power dissipation capability of the energised ZHB part (opposing NPN-PNP switched on) when mounted on a 50mm x 50mm FR4 PCB. The two cases show:

- full copper present and
- with minimal copper present - this being defined as an SM-8 footprint with 1.5mm tracks to the edge of the PCB.

For example, on a 50mm x 50mm full copper PCB, the ZHB6790 will safely dissipate 2W under DC conditions, taking note of continuous current ratings and voltage limits. Higher powers can be tolerated for pulsed operation, while the shorter pulse widths (100µs and 1ms) being relevant for assessment of switching conditions.

The ZHB6790 'H'-Bridge can be modelled within SPICE using the following transistor models configured in the standard 'H'-Bridge topology, as shown in the schematic diagram of this datasheet.

ZETEX H Bridge NPN transistors Spice model Last revision 4/7/97
 .MODEL H6790N NPN IS=2.505E-12 NF=1.0058 BF=1360 IKF=1.3 VAF=35
 +ISE=.24E-12 NE=1.38 NR=1.001 BR=125 IKR=1 VAR=8 ISC=.435E-12
 +NC=1.213 RB=.2 RE=.043 RC=.04 CJC=54.3E-12 MJC=.475 VJC=.765
 +CJE=247E-12 TF=.851E-9 TR=15.7E-9

*

*

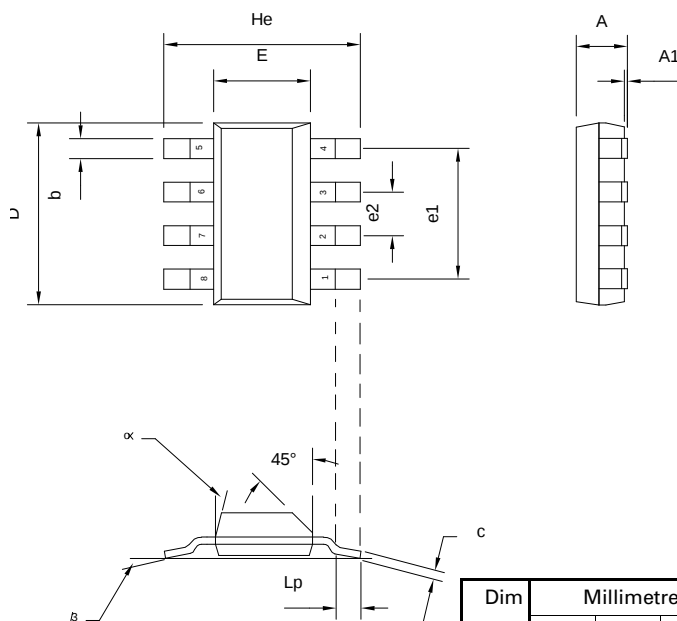
*ZETEX H Bridge PNP transistors Spice model Last revision 4/7/97
 .MODEL H6790P PNP IS=1.09684E-12 NF=1.0102 BF=650 IKF=1.7 VAF=23.5
 +ISE=9.88593E-14 NE=1.47256 NR=1.00391 BR=270 IKR=0.2 VAR=30
 +ISC=5.4933E-14 NC=1.07427 RB=0.055 RE=0.049 RC=0.078 CJC=96E-12
 +MJC=0.495 VJC=0.67 CJE=275E-12 TF=0.75E-9 TR=10.8E-9

*

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Dim	Millimetres			Inches		
	Min	Typ	Max	Min	Typ	Max
A	–	–	1.7	–	–	0.067
A1	0.02	–	0.1	0.0008	–	0.004
b	–	0.7	–	–	0.028	–
c	0.24	–	0.32	0.009	–	0.013
D	6.3	–	6.7	0.248	–	0.264
E	3.3	–	3.7	0.130	–	0.145
e1	–	4.59	–	–	0.180	–
e2	–	1.53	–	–	0.060	–
He	6.7	–	7.3	0.264	–	0.287
Lp	0.9	–	–	0.035	–	–



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